



Feature

High reliability

Small power mold type



**SMA
(DO-214AC)**

Application

Structure



Structure

Silicon Epitaxial Planar

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	1 ¹⁾	W
Operating Junction Temperature	T_j	175	°C
Storage Temperature Range	T_{stg}	- 65 to + 175	°C

¹⁾ Valid provided that electrodes are kept at ambient temperature.

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	170 ¹⁾	°C/W
Forward Voltage at $I_F = 200 \text{ mA}$	V_F	1.2	V

¹⁾ Valid provided that electrodes are kept at ambient temperature.



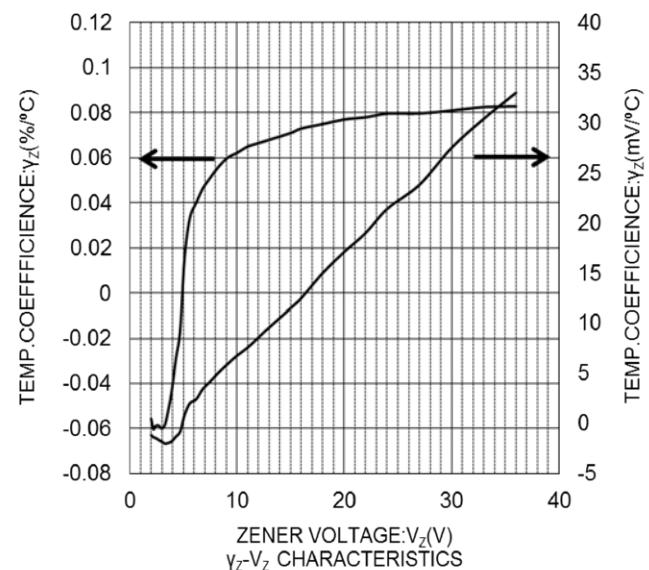
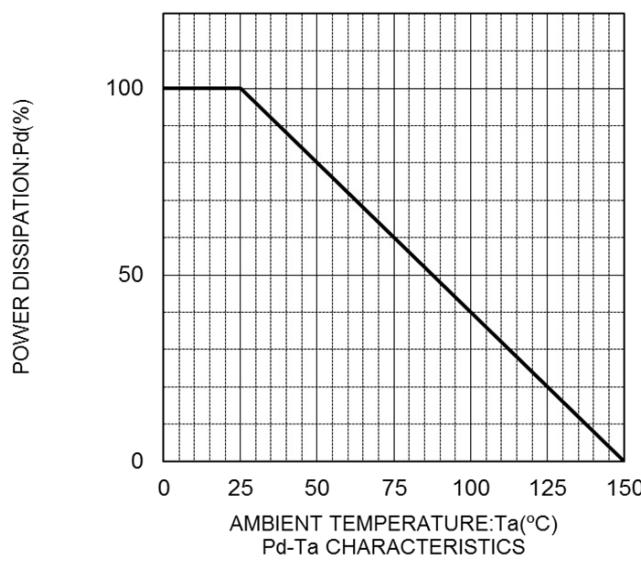
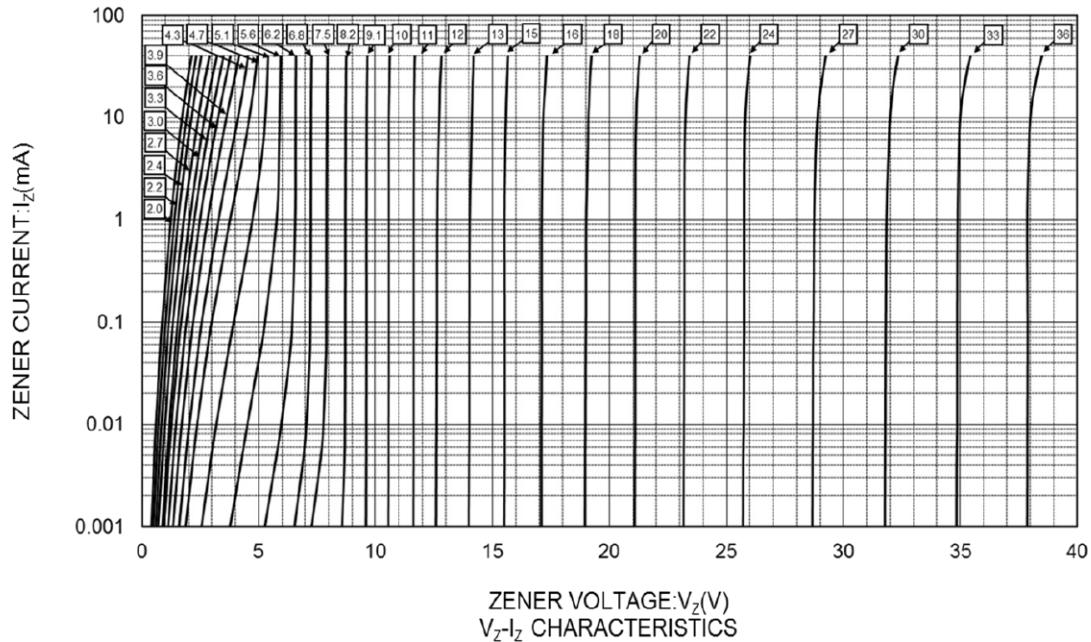
Characteristics at $T_a = 25^\circ\text{C}$

P/N	Symbol						
	Zener Voltage: $V_Z(\text{V})$			Dynamic Impedance: $Z_Z(\Omega)$		Reverse Current: $I_R(\mu\text{A})$	
	MIN.	MAX.	$I_Z(\text{mA})$	MAX.	$I_Z(\text{mA})$	MAX.	$V_R(\text{V})$
PTZ 2.0B	2.000	2.240	40	25	40	200	0.5
PTZ 2.2B	2.200	2.450	40	20	40	200	0.7
PTZ 2.4B	2.400	2.700	40	15	40	200	1.0
PTZ 2.7B	2.700	3.100	40	15	40	200	1.0
PTZ 3.0B	3.000	3.400	40	15	40	100	1.0
PTZ 3.3B	3.300	3.700	40	15	40	80	1.0
PTZ 3.6B	3.600	4.000	40	15	40	60	1.0
PTZ 3.9B	3.900	4.400	40	15	40	40	1.0
PTZ 4.3B	4.300	4.800	40	15	40	20	1.0
PTZ 4.7B	4.700	5.200	40	10	40	20	1.0
PTZ 5.1B	5.100	5.700	40	8	40	20	1.0
PTZ 5.6B	5.600	6.300	40	8	40	20	1.5
PTZ 6.2B	6.200	7.000	40	6	40	20	3.0
PTZ 6.8B	6.800	7.700	40	6	40	20	3.5
PTZ 7.5B	7.500	8.400	40	4	40	20	4.0
PTZ 8.2B	8.200	9.300	40	4	40	20	5.0
PTZ 9.1B	9.100	10.200	40	6	40	20	6.0
PTZ 10B	10.000	11.200	40	6	40	10	7.0
PTZ 11B	11.000	12.300	20	8	20	10	8.0
PTZ 12B	12.000	13.500	20	8	20	10	9.0
PTZ 13B	13.300	15.000	20	10	20	10	10.0
PTZ 15B	14.700	16.500	20	10	20	10	11.0
PTZ 16B	16.200	18.300	20	12	20	10	12.0
PTZ 18B	18.000	20.300	20	12	20	10	13.0
PTZ 20B	20.000	22.400	20	14	20	10	15.0
PTZ 22B	22.000	24.500	10	14	10	10	17.0
PTZ 24B	24.000	27.600	10	16	10	10	19.0
PTZ 27B	27.000	30.800	10	16	10	10	21.0
PTZ 30B	30.000	34.000	10	18	10	10	23.0
PTZ 33B	33.000	37.000	10	18	10	10	25.0
PTZ 36B	36.000	40.000	10	20	10	10	27.0

V_Z test time is 40ms.

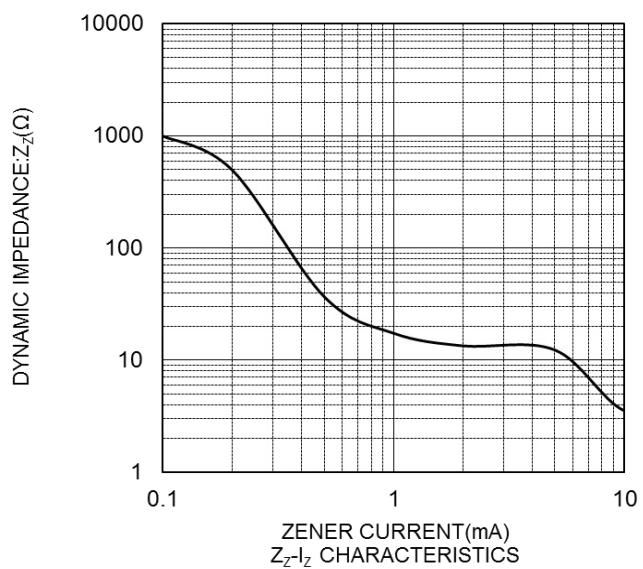
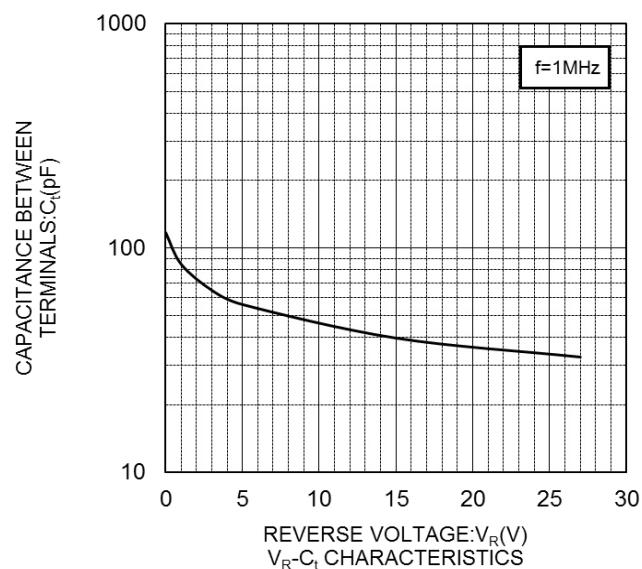
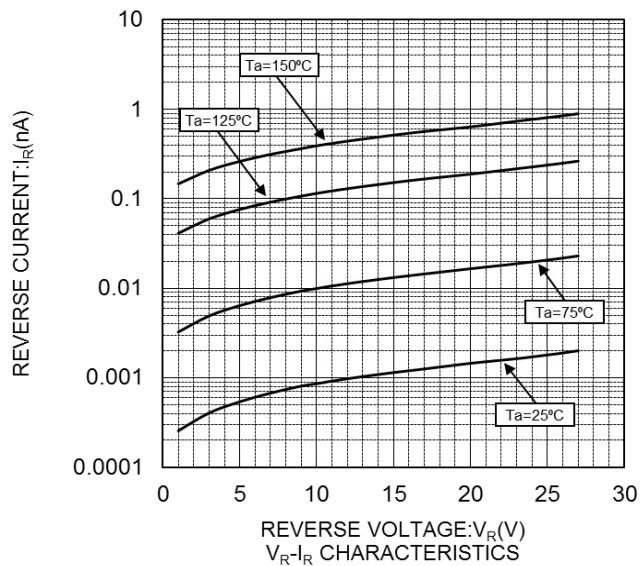
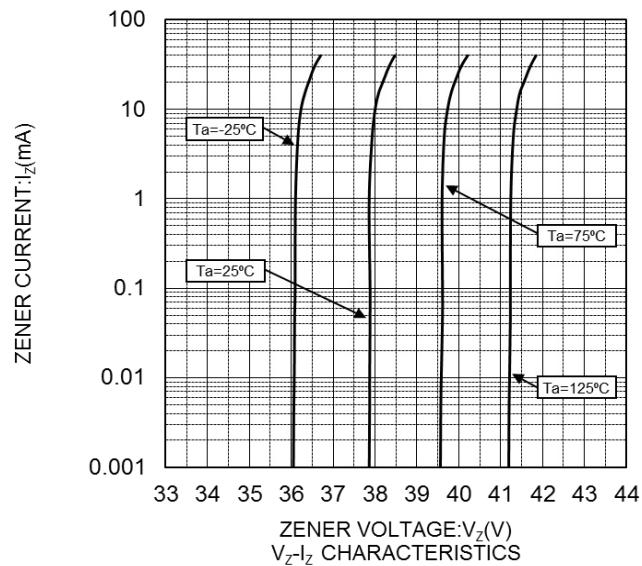


Characteristics at $T_a = 25^\circ\text{C}$





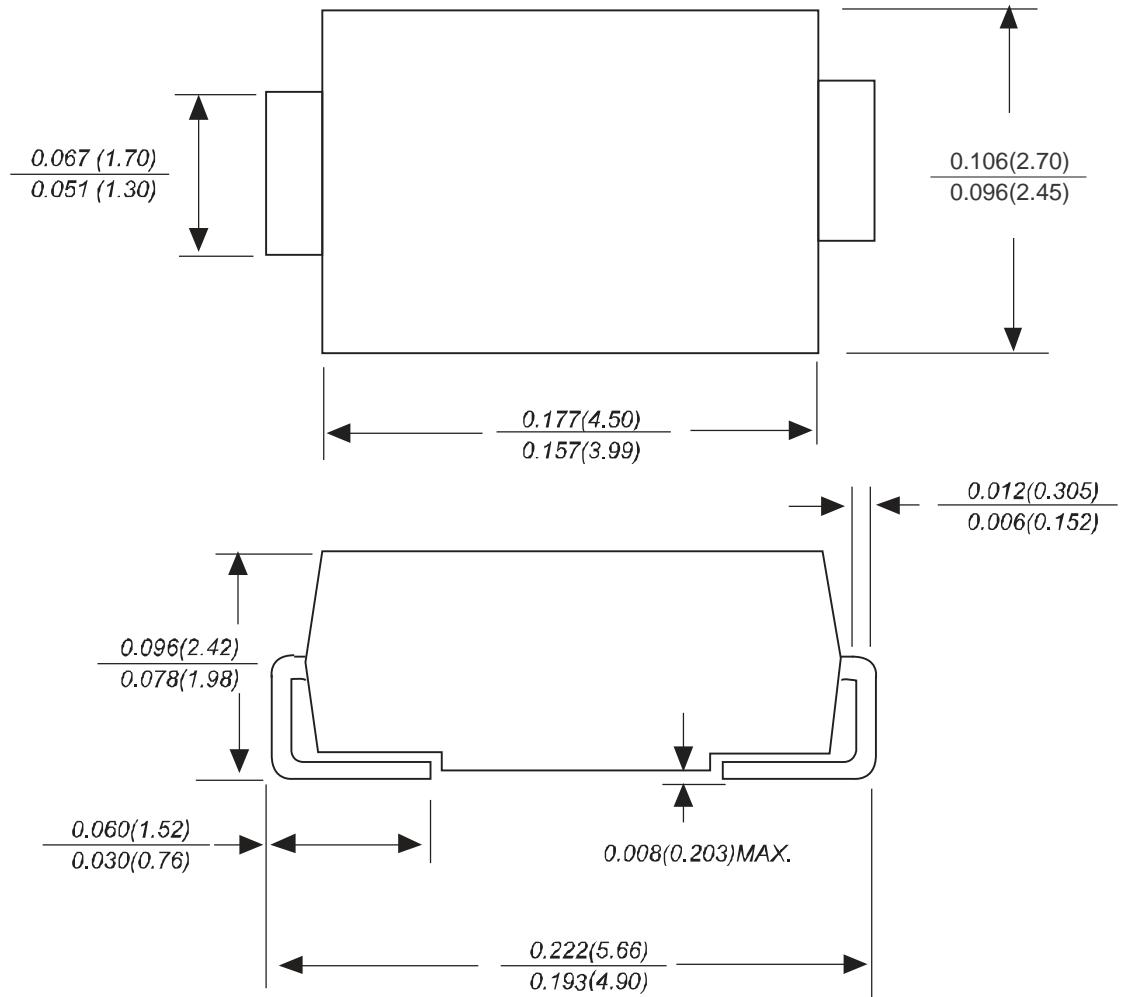
Characteristic Curves





Package Outline Dimensions

SMA(DO-214AC)



Dimensions in inches and (millimeters)



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